# **Modern Reliability Issues**

Ken Stevens

### **Reliability Issues**

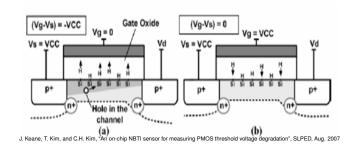
Numerous reliability issues

- 1. Radiation Tolerance
  - single event upset SEU
- 2. Metal Migration
- 3. Hot Electrons
- 4. Negative Bias Temperature Instability (NBTI)

# **Negative Bias Temperature Instability**

- NBTI affects PMOS transistors when gate bias is negative
  - Causes dissociation of hydrogen that lies at interface between channel and insulator
  - · More traps at the interface shifts threshold
- Consists of stress phase and recover phase
- Can result in over 50% reduction in device performance!

#### **NBTI**

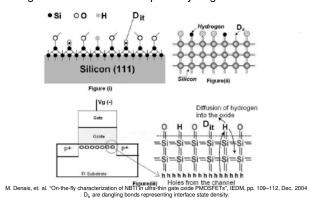


(a) Stress phase

(b) Recovery phase

#### **NBTI Mechanism**

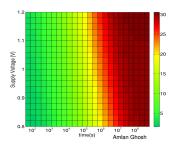
Holes migrate from channel to replace hydrogen



### **Threshold Degradation**

Following chart shows degradation with time and supply voltage for theoretical process.

• actual process values highly protected by foundries



Color axis is shift from nominal  $V_{th}$  in mV